

(C-023-DOT) DC-DC LLC Half-Bridge Buck Converter (DOT247)

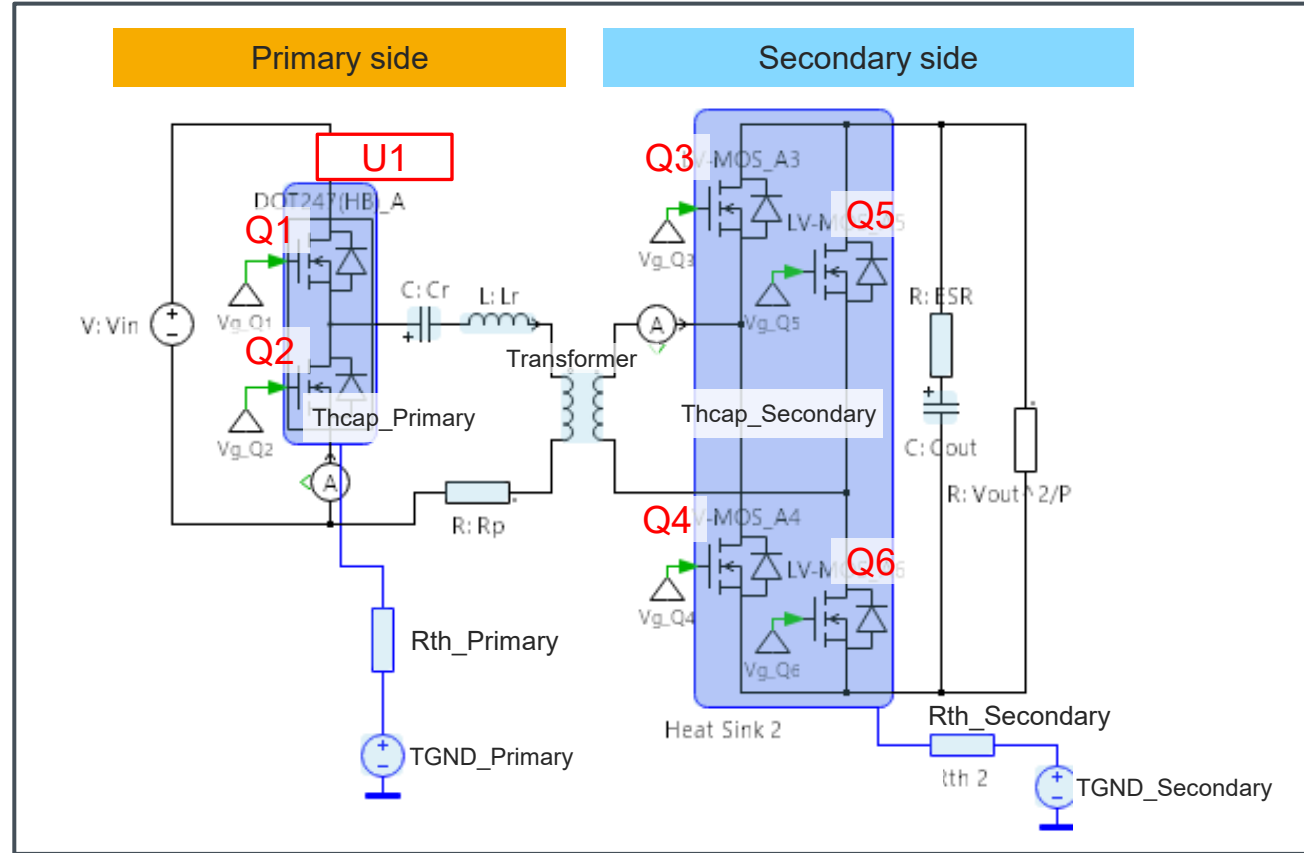
Simulation Parameters

Name	Content	unit	Default Value	Variable Range
Transformer	Np: Primary-turns	turns	9	1 ~ 1,000
	Ns: Secondary-turns	turns	1	1 ~ 1,000
	Lm: Magnetizing Inductance	H	60u	1n~1
Rp	Transformer Resistance	Ω	1m	1m ~ 1
Lr	Resonant Inductance	H	12u	1n ~ 1
Cr	Resonant Capacitance	F	100n	1n ~ 1
Cout	Output Capacitance	F	4.7m	1n ~ 1
	Initial Voltage	V	50	0 ~ 80
ESR	ESR of Cout	Ω	15m	1m ~ 1
Primary	Thcap_Primary	J/K	0.1	1m ~ 100
	Rth_Primary	K/W	0.2	1m ~ 100
	TGND_Primary	Ambient Temperature	$^{\circ}\text{C}$	25
Secondary	Thcap_Secondary	J/K	0.1	1m ~ 100
	Rth_Secondary	K/W	0.2	1m ~ 100
	TGND_Secondary	Ambient Temperature	$^{\circ}\text{C}$	25

Name	Content	unit	Default Value	Variable Range	
Test_time	Test time in simulation	s	0.3	100u ~ 1	
Vin_dc	Input Voltage	V	800	400 ~ 1,200	
Vout_dc	Output Voltage	V	50	10 ~ 80	
Pout	Output Power	W	5,000	100~10,000	
fs_ref	Target Carrier Frequency	Hz	100k	10k~500k	
Primary	Rg_on 1*	Gate Resistance (Source)	Ω	8.2	0.1 ~ 100
	Rg_off 1*	Gate Resistance (Sink)	Ω	4.7	0.1 ~ 100
	DT1	Dead Time	s	200n	0 ~ 1m
Secondary	Rg_on 2*	Gate Resistance (Source)	Ω	10	0.1 ~ 100
	Rg_off 2*	Gate Resistance (Sink)	Ω	10	0.1 ~ 100
	DT2	Dead Time	s	200n	0 ~ 1m
T_init**	Initial Junction Temp.	$^{\circ}\text{C}$	25	-40 ~ 175	

*Common for all MOSFETs in the same side. **Common for all devices

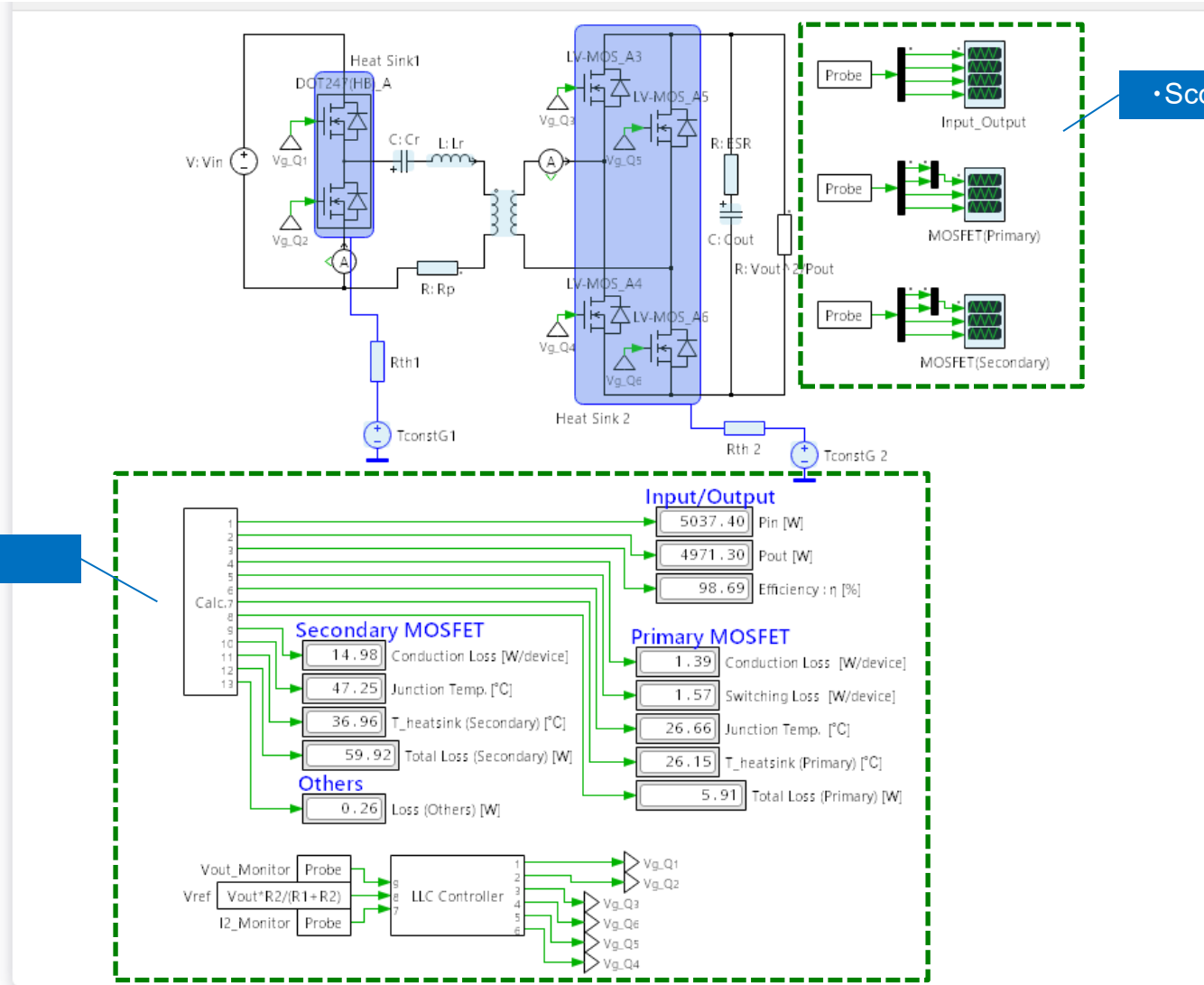
Simulation Circuit



Default Devices

Name	Device Type	Part No.	Specification
U1	SiC MOSFET module	SCZ4006KTA	1200V/ 209A/ 6m Ω / DOT247 (Half-bridge)
Q3~6	Si MOSFET	RS7N200BH	80V/ 200A/ 1.7m Ω / DFN5060-8S

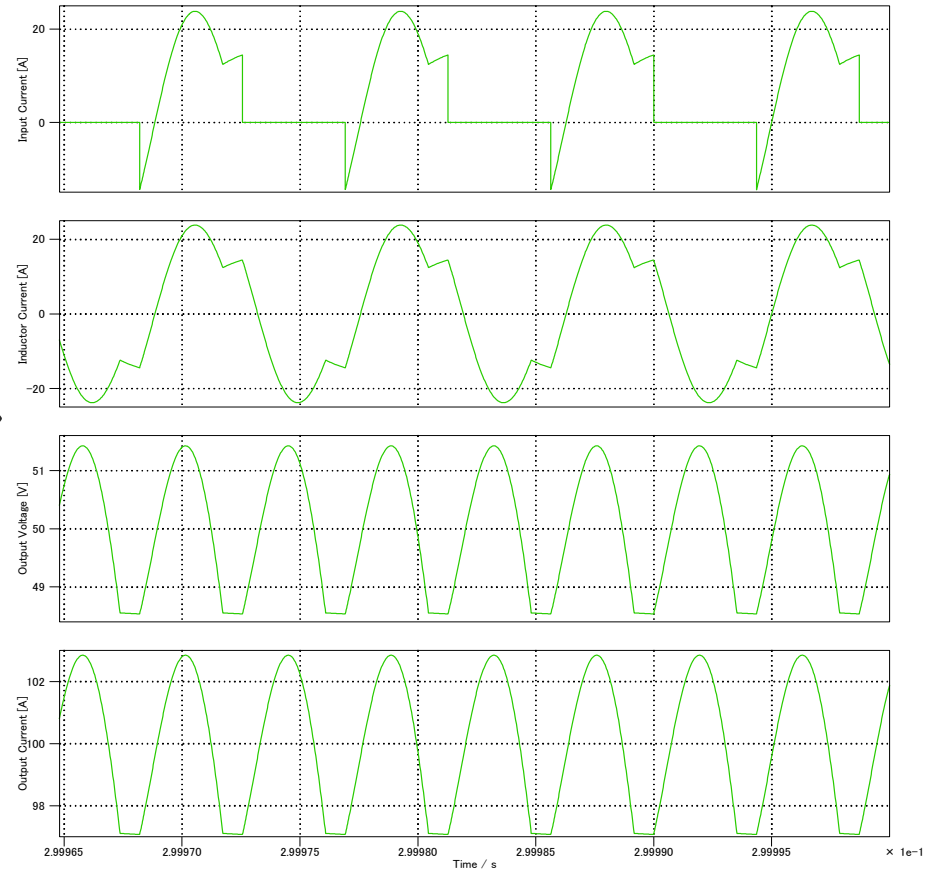
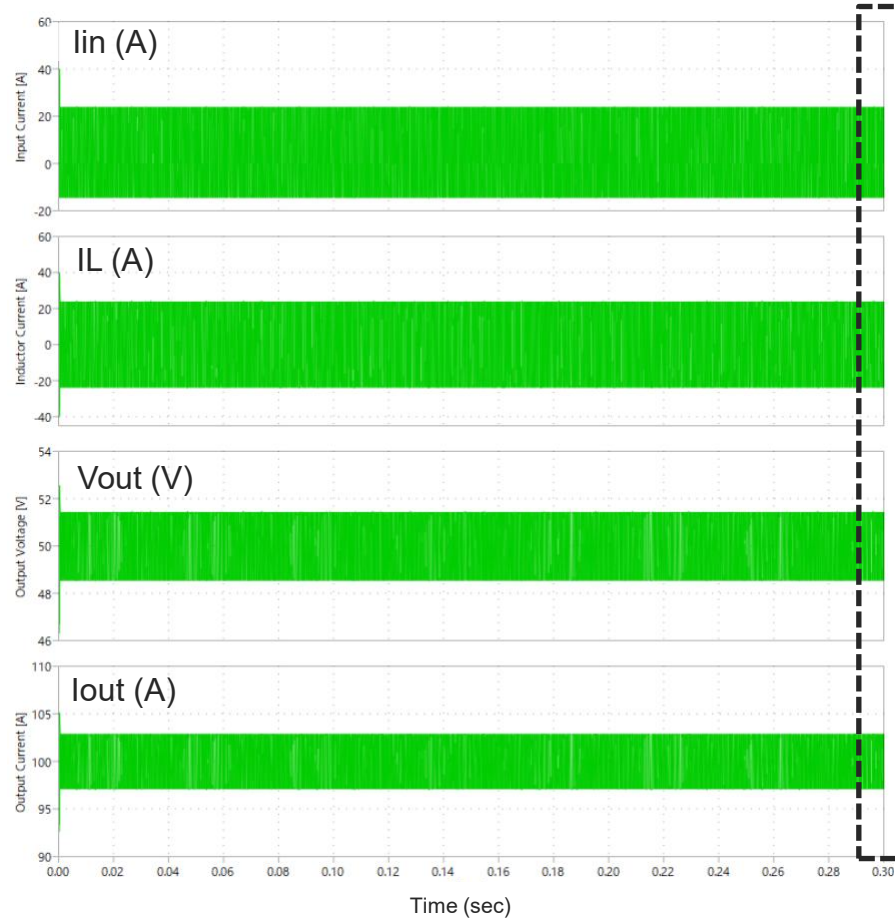
Schematic window



• Results display

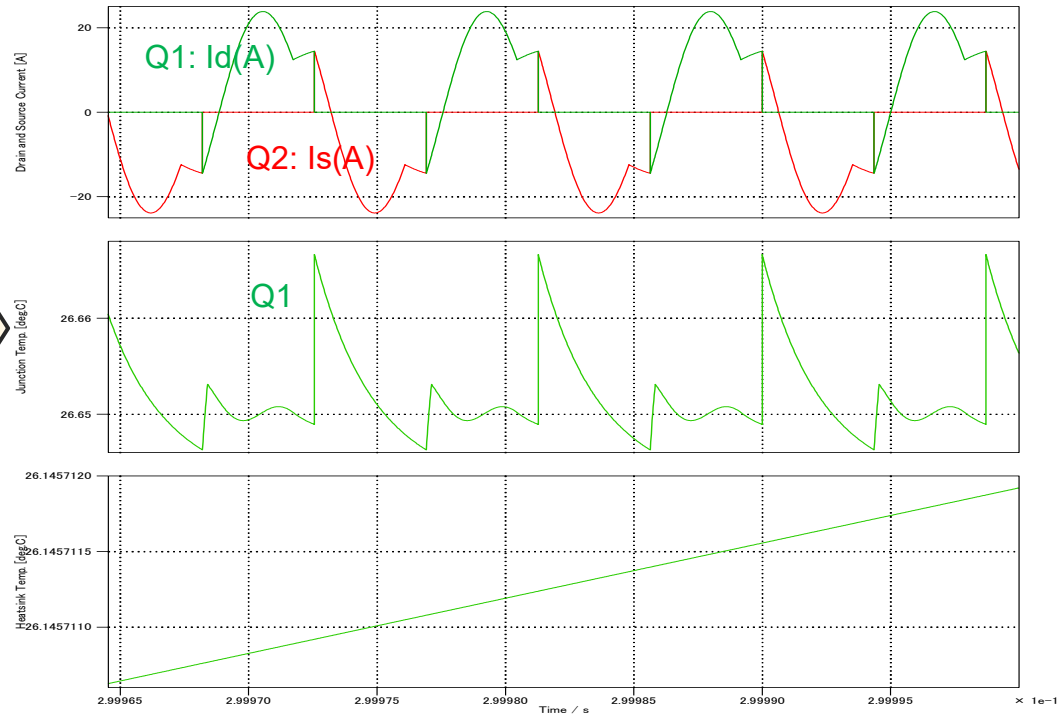
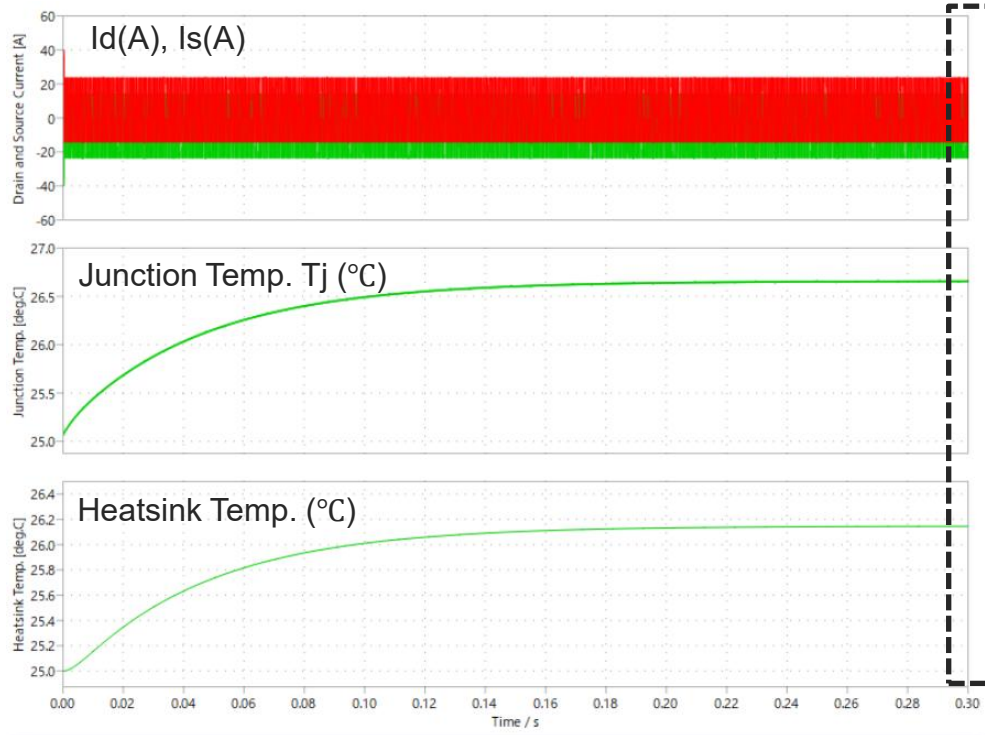
• Scope the waveform

Input and Output



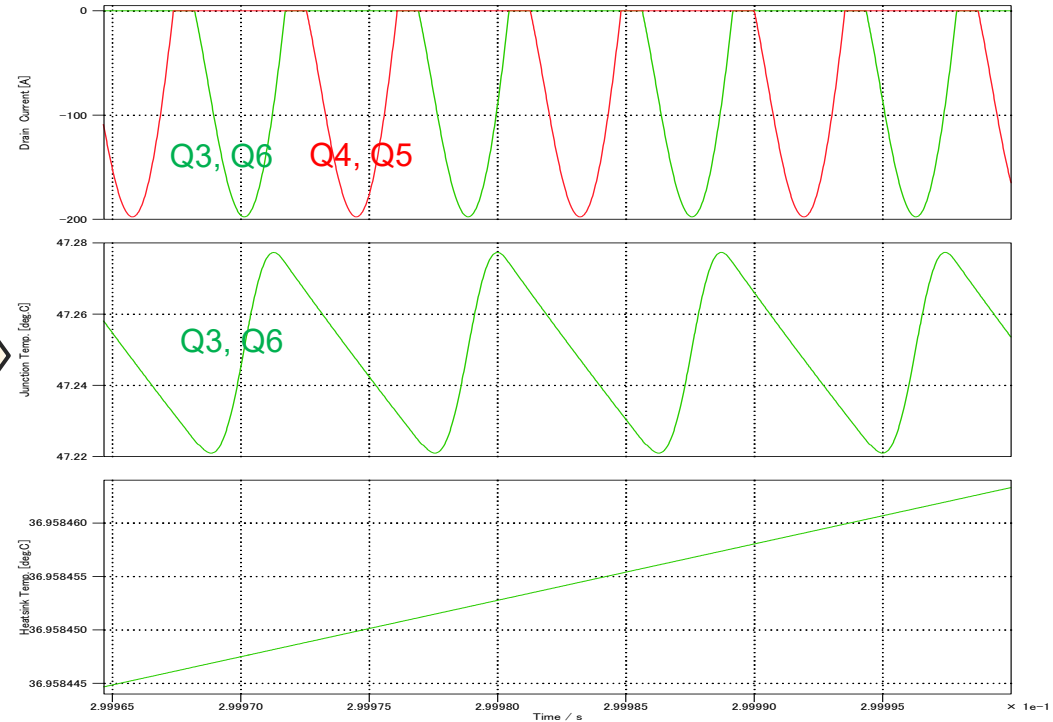
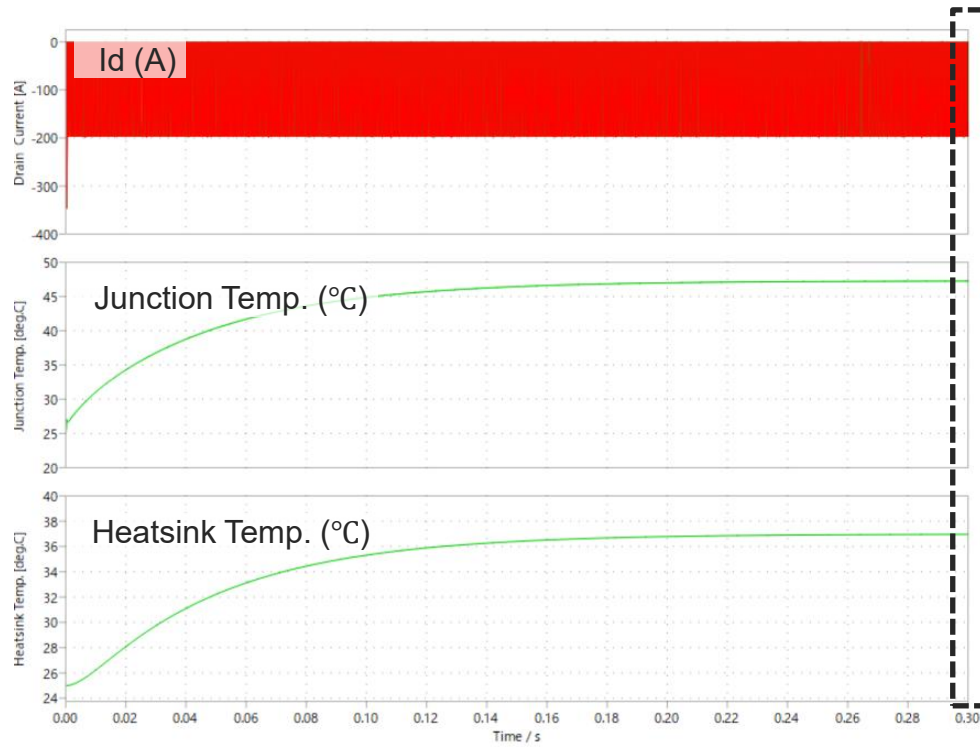
Contents	Results
Input Power : Pin	5.101 (kW)
Output Power: Pout	5.010 (kW)
Efficiency: η	98.21 (%)

Primary side



Contents	Results
Conduction Loss: Pcond (primary)	1.38 (W/device)
Switching Loss: Psw (primary)	1.55 (W/device)
Junction Temp. : Tj (primary)	26.64 (°C)
Heatsink Temp.: T_hs (primary)	26.14 (°C)
Total Loss: Ptot (primary)	5.87 (W)

Secondary side



Contents	Results
Conduction Loss: Pcond (secondary)	13.28 (W/device)
Junction Temp. : Tj (secondary)	47.47 (°C)
Heatsink Temp.: T_hs (secondary)	37.06 (°C)
Total Loss: Ptot (secondary)	53.13 (W)

To run this PLECS Reference Circuit, you must have the "PLECS" simulation software installed on your computer.

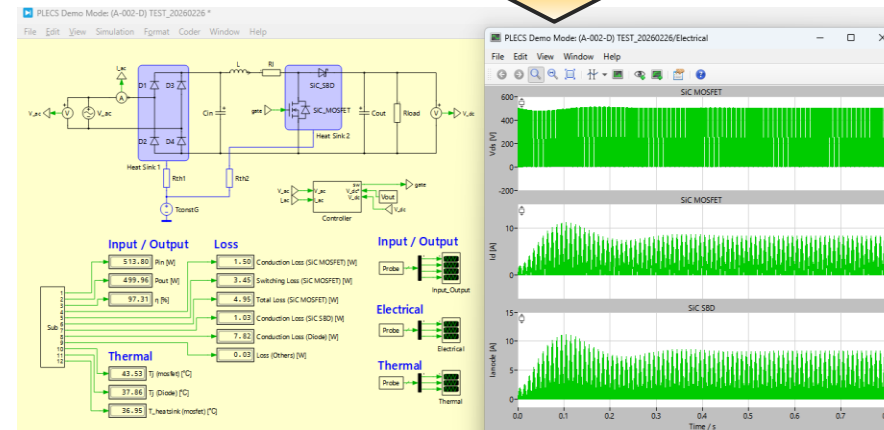
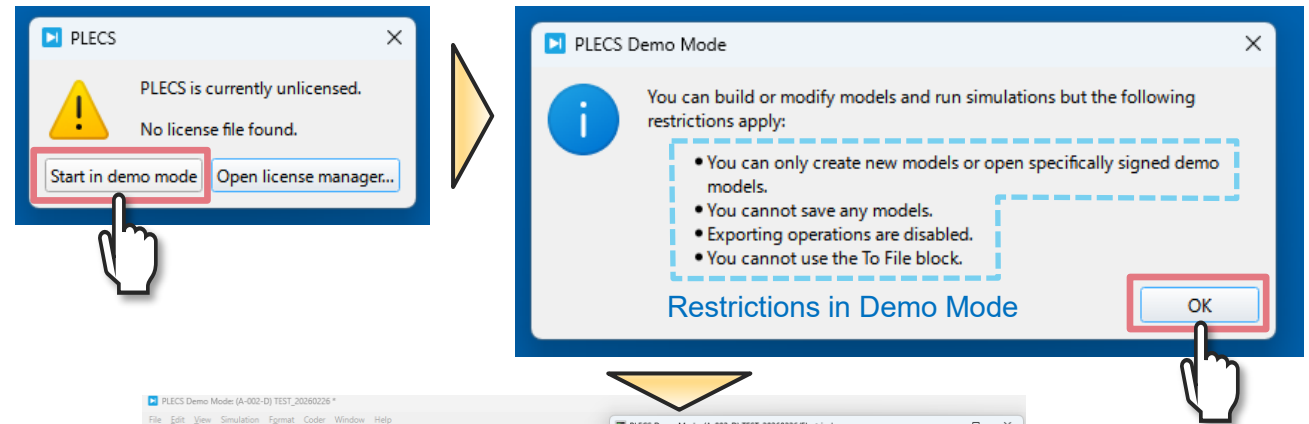
1. Obtaining the Software

If you do not have PLECS installed, please download the installer from the official website and complete the setup process.

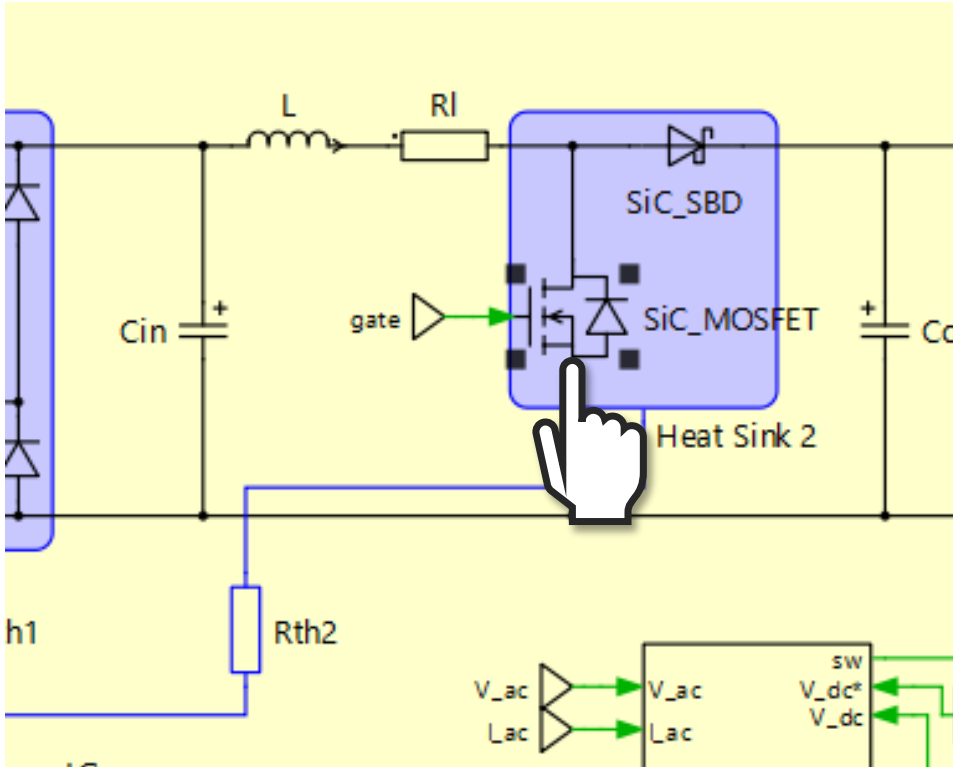
<https://www.plexim.com/download>

2. Licensing (Using Demo Mode)

This reference circuit can be executed and viewed in "Demo Mode" even if you do not possess a paid license.



Schematic window



Block Parameters: (A-002-D) AC-DC Boost PFC Diode Rectific... X

SiC-MOSFET (mask)

Model Generated by ROHM
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Commercial Use or Resale Restricted

Date: 21-Jan.-2026

Parameters Assertions

SiC-MOSFET:
SiCMOS

Custom variables:
struct('Rg_on', 'Rg_on', 'Rg_off', 'Rg_off', 'sw', 'sw')

Gate resistance (on):
Rg_on

Gate resistance (off):
Rg_off

Initial temperature:
T_init

Initial Ron:
Ron_init

OK Cancel Apply Help

- From library...
- By reference
- Edit...
- Remove
- New thermal description...
- New thermal package description...

[SiC-MOSFET] TO-247-4L_750V_25A_65mΩ (SCT4065DR)
[SiC-MOSFET] TO-247-4L_750V_34A_45mΩ (SCT4045DR)
[SiC-MOSFET] TO-247-4L_750V_42A_36mΩ (SCT4036DR)
[SiC-MOSFET] TO-247-4L_750V_56A_26mΩ (SCT4026DR)
[SiC-MOSFET] TO-247N_1200V_19A_90mΩ (SCT4090KE)
[SiC-MOSFET] TO-247N_1200V_26A_62mΩ (SCT4062KE)
[SiC-MOSFET] TO-247N_1200V_32A_50mΩ (SCT4050KE)
[SiC-MOSFET] TO-247N_1200V_40A_36mΩ (SCT4036KE)
[SiC-MOSFET] TO-247N_1200V_81A_18mΩ (SCT4018KE)
[SiC-MOSFET] TO-247N_750V_105A_13mΩ (SCT4013DE)
[SiC-MOSFET] TO-247N_750V_25A_65mΩ (SCT4065DE)
[SiC-MOSFET] TO-247N_750V_34A_45mΩ (SCT4045DE)
[SiC-MOSFET] TO-247N_750V_42A_36mΩ (SCT4036DE)
[SiC-MOSFET] TO-247N_750V_56A_26mΩ (SCT4026DE)
[SiC-MOSFET] TO-263-7LA_1200V_17A_90mΩ (SCT4090KWA)
[SiC-MOSFET] TO-263-7LA_1200V_24A_62mΩ (SCT4062KWA)
[SiC-MOSFET] TO-263-7LA_1200V_29A_50mΩ (SCT4050KWA)
[SiC-MOSFET] TO-263-7LA_1200V_40A_36mΩ (SCT4036KWA)
[SiC-MOSFET] TO-263-7LA_1200V_75A_18mΩ (SCT4018KWA)
[SiC-MOSFET] TO-263-7LA_750V_22A_65mΩ (SCT4065DWA)
[SiC-MOSFET] TO-263-7LA_750V_31A_45mΩ (SCT4045DWA)
[SiC-MOSFET] TO-263-7LA_750V_38A_36mΩ (SCT4036DWA)
[SiC-MOSFET] TO-263-7LA_750V_51A_26mΩ (SCT4026DWA)
[SiC-MOSFET] TOLL_750V_120A_13mΩ (SCT4013DLL)
[SiC-MOSFET] TOLL_750V_26A_65mΩ (SCT4065DLL)
[SiC-MOSFET] TOLL_750V_37A_45mΩ (SCT4045DLL)

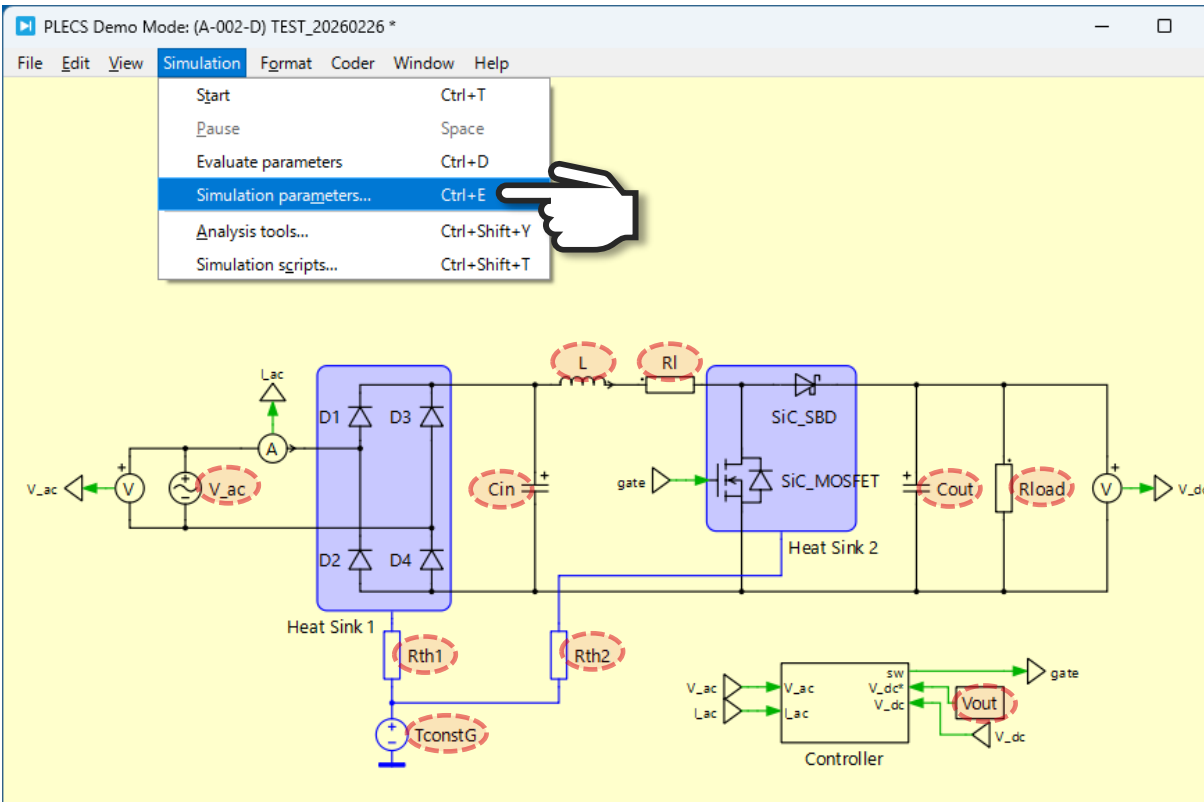
Hover your mouse cursor over the device symbol that you want to change and double-click the left button of the mouse.

Click "... " > "From library..." to view the list of available devices and you can select a favorite device from these.

If the model you need is not in the list, please refer to the application note "[How to Use PLECS Models](#)".

How to change the simulation parameters

Schematic window



The 'Simulation Parameters' dialog box is shown with the 'Initialization' tab selected. The 'Model initialization commands' section contains the following parameterized code:

```
1 % General|
2 Test time = 0.8; % End time of simulation [s]
3 SiCMOS = 'file:SC14065DR';
4 SiCSBD = 'file:SCS320AG';
5
6 % Grid
7 Vin = 100;
8 %Wac = Vin*sqrt(2); % Grid voltage [V]
9 Vout = 500
10 F = 50.0; % Grid frequency [Hz]
11
12 % Plant
13 fs_k = 50; % Switching frequency [kHz]
14 %fs = fs_k*1e3; % Switching frequency [Hz]
15
16 Rl = 0.001
17 Rload = 500; % Load resistance [ohms]
18 Rsense = 0.0025; % Sense resistance [ohms]
19 L = 1e-3; % Choke inductance [H]
20 Cin = 0.1e-6; % Input capacitor [C]
21 Cout = 1e-3; % Output capacitor [C]
22 C1 = 470e-9; % Reference capacitor [C]
23
24 %Wcout_init = Vout; %Initial Voltage of Output Capacitor [V]
25
26
27 R_Di = 0.02; % Diode On-resistance [ohm]
28 V_F_Di = 0.6; % Diode On-resistance [ohm]
29
30 % Thermal system
31 T_init = 25; % Initial Temperature of Heatsink [deg.C]
32 Thcap_1 = 0.001; % Thermal capacitance of Heatsink [J/K]
33 Thcap_2 = 0.001; % Thermal capacitance of Heatsink [J/K]
34 Rth_1 = 2.0; % Thermal Resistance [K/W]
35 Rth_2 = 2.0; % Thermal Resistance [K/W]
36 T_GND = 25; %Thermal GND Temperature [deg.C]
37
```

All simulation parameters are parameterized. To modify them, go to the menu, select "Simulation parameters..." , and edit the values within "Model initialization commands."

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